

80186/80188 HIGH-INTEGRATION 16-BIT MICROPROCESSORS

- Integrated Feature Set
 - Enhanced 8086-2 CPU
 - Clock Generator
 - 2 Independent DMA Channels
 - Programmable Interrupt Controller
 - 3 Programmable 16-bit Timers
 - Programmable Memory and Peripheral Chip-Select Logic
 - Programmable Wait State Generator
 - Local Bus Controller
- Available in 10 MHz and 8 MHz Versions
- High-Performance Processor
 - 4 Mbyte/Sec Bus Bandwidth Interface @ 8 MHz (80186)
 - 5 Mbyte/Sec Bus Bandwidth Interface @ 10 MHz (80186)

- Direct Addressing Capability to 1 Mbyte of Memory and 64 Kbyte I/O
- Completely Object Code Compatible with All Existing 8086, 8088 Software — 10 New Instruction Types
- **Numerics Coprocessing Capability** Through 8087 Interface
- Available in 68 Pin:
 - Plastic Leaded Chip Carrier (PLCC)
 - Ceramic Pin Grid Array (PGA)
 - Ceramic Leadless Chip Carrier (LCC)
- Available in EXPRESS
 - WWW.DZSC.COM — Standard Temperature with Burn-In
 - Extended Temperature Range $(-40^{\circ}C \text{ to } +85^{\circ}C)$

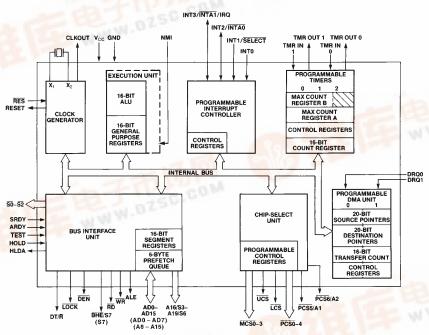


Figure 1. Block Diagram

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80186/80188 High-Integration 16-Bit Microprocessors

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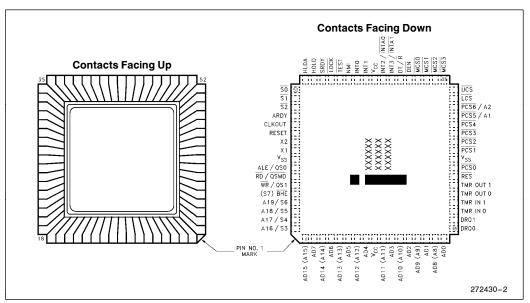


Figure 2. Ceramic Leadless Chip Carrier (JEDEC Type A)

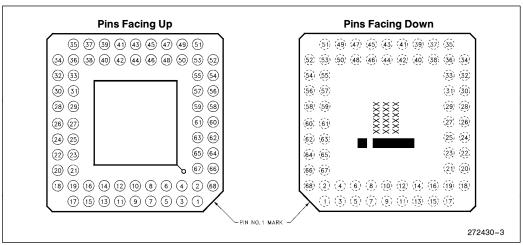


Figure 3. Ceramic Pin Grid Array



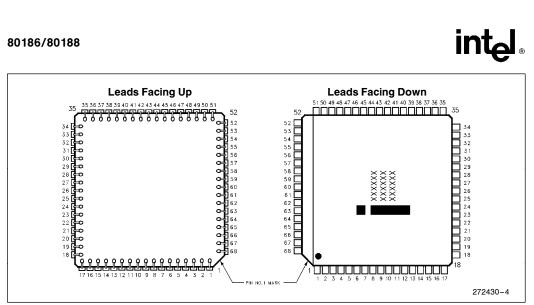


Figure 4. Plastic Leaded Chip Carrier



Table 1. Pin Descriptions

	Table 1. Pin Descriptions							
Symbol	Pin No.	Туре	Name and Function					
V _{CC}	9 43	I	SYSTEM POWER: +5 volt power supply.					
V _{SS}	26 60	ı	System Ground.					
RESET	57	0	Reset Output indicates that the CPU is being reset, and can be used as a system reset. It is active HIGH, synchronized with the processor clock, and lasts an integer number of clock periods corresponding to the length of the RES signal.					
X1 X2	59 58	0	Crystal Inputs X1 and X2 provide external connections for a fundamental mode parallel resonant crystal for the internal oscillator. Instead of using a crystal, an external clock may be applied to X1 while minimizing stray capacitance on X2. The input or oscillator frequency is internally divided by two to generate the clock signal (CLKOUT).					
CLKOUT	56	0	Clock Output provides the system with a 50% duty cycle waveform. All device pin timings are specified relative to CLKOUT.					
RES	24	I	An active $\overline{\text{RES}}$ causes the processor to immediately terminate its present activity, clear the internal logic, and enter a dormant state. This signal may be asynchronous to the processor clock. The processor begins fetching instructions approximately $6\frac{1}{2}$ clock cycles after $\overline{\text{RES}}$ is returned HIGH. For proper initialization, V_{CC} must be within specifications and the clock signal must be stable for more than 4 clocks with $\overline{\text{RES}}$ held LOW. $\overline{\text{RES}}$ is internally synchronized. This input is provided with a Schmitt-trigger to facilitate power-on $\overline{\text{RES}}$ generation via an RC network.					
TEST	47	1/0	TEST is examined by the WAIT instruction. If the TEST input is HIGH when "WAIT" execution begins, instruction execution will suspend. TEST will be resampled until it goes LOW, at which time execution will resume. If interrupts are enabled while the processor is waiting for TEST, interrupts will be serviced. During power-up, active RES is required to configure TEST as an input. This pin is synchronized internally.					
TMR IN 0 TMR IN 1	20 21	I I	Timer Inputs are used either as clock or control signals, depending upon the programmed timer mode. These inputs are active HIGH (or LOW-to-HIGH transitions are counted) and internally synchronized.					
TMR OUT 0 TMR OUT 1	22 23	0	Timer outputs are used to provide single pulse or continous waveform generation, depending upon the timer mode selected.					
DRQ0 DRQ1	18 19	1	DMA Request is asserted HIGH by an external device when it is ready for DMA Channel 0 or 1 to perform a transfer. These signals are level-triggered and internally synchronized.					
NMI	46	I	The Non-Maskable Interrupt input causes a Type 2 interrupt. An NMI transition from LOW to HIGH is latched and synchronized internally, and initiates the interrupt at the next instruction boundary. NMI must be asserted for at least one clock. The Non-Maskable Interrupt cannot be avoided by programming.					
INT0 INT1/SELECT INT2/INTA0 INT3/INTA1/IRQ	45 44 42 41	 1 1/0 1/0	Maskable Interrupt Requests can be requested by activating one of these pins. When configured as inputs, these pins are active HIGH. Interrupt Requests are synchronized internally. INT2 and INT3 may be configured to provide active-LOW interrupt-acknowledge output signals. All interrupt inputs may be configured to be either edge- or level-triggered. To ensure recognition, all interrupt requests must remain active until the interrupt is acknowledged. When Slave Mode is selected, the function of these pins changes (see Interrupt Controller section of this data sheet).					



Table 1. Pin Descriptions (Continued)

	Pin Pin								
Symbol	No.	Туре		Name and Function					
A19/S6 A18/S5	65 66	0	Address Bus Outputs (16–19) and Bus Cycle Status (3–6) indicate the four most significant address bits during T_1 . These signals are active HIGH. During T_2 , T_3 , T_W ,						
A17/S4	67	0		and T ₄ , the S6 pin is LOW to indicate a CPU-initiated bus cycle or HIGH to indicate a					
A16/S3	68	0		DMA-initiated bus cycle. During the same T-states, S3, S4, and S5 are always LOW. The status pins float during bus HOLD or RESET.					
AD15 (A15)	1	1/0			us signals constitute the time multiplexed memory or I/O address (T ₁)				
AD14 (A14) AD13 (A13)	3 5	1/0 1/0			, T_W , and T_4) bus. The bus is active HIGH. A_0 is analogous to BHE for f the data bus, pins D_7 through D_0 . It is LOW during T_1 when a byte is				
AD12 (A12)	7	1/0			d onto the lower portion of the bus in memory or I/O operations. BHE				
AD11 (A11)	10	1/0	does no	ot exist o	n the 80188, as the data bus is only 8 bits wide.				
AD10 (A10)	12	1/0							
AD9 (A9) AD8 (A8)	14 16	I/O I/O							
AD0 (A0) AD7	2	1/0							
AD6	4	1/0							
AD5	6	1/0							
AD4	8	1/0							
AD3 AD2	11 13	I/O I/O							
AD1	15	1/0							
AD0	17	1/0							
BHE/S7 (S7)	64	0	enabled during transfer T ₂ , T ₃ ,	During T_1 the Bus High Enable signal should be used to determine if data is to be enabled onto the most significant half of the data bus; pins $D_{15}-D_8$. \overline{BHE} is LOW during T_1 for read, write, and interrupt acknowledge cycles when a byte is to be transferred on the higher half of the bus. The S_7 status information is available during T_2 , T_3 , and T_4 . S_7 is logically equivalent to \overline{BHE} . $\overline{BHE}/S7$ floats during HOLD. On the 80188, S7 is high during normal operation.					
					BHE and A0 Encodings (80186 Only)				
			BHE Value	A0 Value	Function				
			0	0	Word Transfer				
			0	1 0	Byte Transfer on upper half of data bus (D15–D8)				
			1 1	1	Byte Transfer on lower half of data bus (D_7-D_0) Reserved				
ALE/QS0	61	0	Address Latch Enable/Queue Status 0 is provided by the processor to latch the address. ALE is active HIGH. Addresses are guaranteed to be valid on the trailing edge of ALE. The ALE rising edge is generated off the rising edge of the CLKOUT immediately preceding T ₁ of the associated bus cycle, effectively one-half clock cycle earlier than in the 8086. The trailing edge is generated off the CLKOUT rising edge in T ₁ as in the 8086. Note that ALE is never floated.						
WR/QS1	63	0			ueue Status 1 indicates that the data on the bus is to be written into a				
			memory or an I/O device. \overline{WR} is active for T_2 , T_3 , and T_W of any write cycle. It is active LOW, and floats during HOLD. When the processor is in queue status mode, the ALE/QS0 and \overline{WR} /QS1 pins provide information about processor/instruction queue interaction.						
			QS1	QS0	Queue Operation				
			0	0	No queue operation				
			0	1	First opcode byte fetched from the queue				
			1 1	1 0	Subsequent byte fetched from the queue Empty the queue				
			•	·	months are decay				



Table 1. Pin Descriptions (Continued)

	l able 1. Pin Descriptions (Continued)								
Symbol	Pin No.	Туре	Name and Function						
RD/QSMD	62	I/O	Read Strobe is an active LOW signal which indicates that the processor is performing a memory or I/O read cycle. It is guaranteed not to go LOW before the A/D bus is floated. An internal pull-up ensures that \overline{RD} is HIGH during RESET. Following RESET the pin is sampled to determine whether the processor is to provide ALE, \overline{RD} , and \overline{WR} , or queue status information. To enable Queue Status Mode, \overline{RD} must be connected to GND. \overline{RD} will float during bus HOLD.						
ARDY	55	I	spac rising fallin Con	Asynchronous Ready informs the processor that the addressed memory space or I/O device will complete a data transfer. The ARDY pin accepts a rising edge that is asynchronous to CLKOUT, and is active HIGH. The falling edge of ARDY must be synchronized to the processor clock. Connecting ARDY HIGH will always assert the ready condition to the CPU. If this line is unused, it should be tied LOW to yield control to the SRDY pin.					
SRDY	49	I	space active relaxe the consignation Signation	Synchronous Ready informs the processor that the addressed memory space or I/O device will complete a data transfer. The SRDY pin accepts an active-HIGH input synchronized to CLKOUT. The use of SRDY allows a relaxed system timing over ARDY. This is accomplished by elimination of the one-half clock cycle required to internally synchronize the ARDY input signal. Connecting SRDY high will always assert the ready condition to the CPU. If this line is unused, it should be tied LOW to yield control to the ARDY pin.					
LOCK	48	0	cont requ of th prefi instr more code	LOCK output indicates that other system bus masters are not to gain control of the system bus while LOCK is active LOW. The LOCK signal is requested by the LOCK prefix instruction and is activated at the beginning of the first data cycle associated with the instruction following the LOCK prefix. It remains active until the completion of that instruction. No instruction prefetching will occur while LOCK is asserted. When executing more than one LOCK instruction, always make sure there are 6 bytes of code between the end of the first LOCK instruction and the start of the second LOCK instruction. LOCK is driven HIGH for one clock during RESET					
<u>S0</u>	52	0				$\overline{S0} - \overline{S2}$ are encoded to provide bus-transaction			
S1 S2	53 54	0	intor	matior	1:	Bus Cycle Status Information			
			<u>S2</u>	<u>S1</u>	<u>50</u>	Bus Cycle Initiated			
			0 0 0 0 1 1 1 1 1	0 0 1 1 0 0 1 1 1	0 1 0 1 0 1 0 1	Interrupt Acknowledge Read I/O Write I/O Halt Instruction Fetch Read Data from Memory Write Data to Memory Passive (no bus cycle) oat during HOLD.			
			S2 n	nay be	used a	as a logical M/ $\overline{\text{IO}}$ indicator, and $\overline{\text{S1}}$ as a DT/ $\overline{\text{R}}$ indicator.			



Table 1. Pin Descriptions (Continued)

l able 1. Pin Descriptions (Continued)							
Symbol	Pin No.	Туре	Name and Function				
HOLD HLDA	50 51	0	HOLD indicates that another bus master is requesting the local bus. The HOLD input is active HIGH. HOLD may be asynchronous with respect to the processor clock. The processor will issue a HLDA (HIGH) in response to a HOLD request at the end of T_4 or T_i . Simultaneous with the issuance of HLDA, the processor will float the local bus and control lines. After HOLD is detected as being LOW, the processor will lower HLDA. When the processor needs to run another bus cycle, it will again drive the local bus and control lines.				
UCS	34	0	Upper Memory Chip Select is an active LOW output whenever a memory reference is made to the defined upper portion (1K-256K block) of memory. This line is not floated during bus HOLD. The address range activating UCS is software programmable.				
<u>ICS</u>	33	0	Lower Memory Chip Select is active LOW whenever a memory reference is made to the defined lower portion (1K-256K) of memory. This line is not floated during bus HOLD. The address range activating LCS is software programmable.				
MCS0 MCS1 MCS2 MCS3	38 37 36 35	0 0 0 0	Mid-Range Memory Chip Select signals are active LOW when a memory reference is made to the defined mid-range portion of memory (8K–512K). These lines are not floated during bus HOLD. The address ranges activating MCS0-3 are software programmable.				
PCS0 PCS1 PCS2 PCS3 PCS4	25 27 28 29 30	0 0 0 0	Peripheral Chip Select signals 0-4 are active LOW when a reference is made to the defined peripheral area (64 Kbyte I/O space). These lines are not floated during bus HOLD. The address ranges activating PCS0-4 are software programmable.				
PCS5/A1	31	0	Peripheral Chip Select 5 or Latched A1 may be programmed to provide a sixth peripheral chip select, or to provide an internally latched A1 signal. The address range activating PCS5 is software-programmable. PCS5/A1 does not float during bus HOLD. When programmed to provide latched A1, this pin will retain the previously latched value during HOLD.				
PCS6/A2	32	0	Peripheral Chip Select 6 or Latched A2 may be programmed to provide a seventh peripheral chip select, or to provide an internally latched A2 signal. The address range activating PCS6 is software programmable. PCS6/A2 does not float during bus HOLD. When programmed to provide latched A2, this pin will retain the previously latched value during HOLD.				
DT/R	40	0	Data Transmit/Receive controls the direction of data flow through an external data bus transceiver. When LOW, data is transferred to the processor. When HIGH, the processor places write data on the data bus.				
DEN	39	0	Data Enable is provided as a data bus transceiver output enable. DEN is active LOW during each memory and I/O access. DEN is HIGH whenever DT/R changes state. During RESET, DEN is driven HIGH for one clock, then floated. DEN also floats during HOLD.				



FUNCTIONAL DESCRIPTION

Introduction

The following Functional Description describes the base architecture of the 80186. The 80186 is a very high integration 16-bit microprocessor. It combines 15–20 of the most common microprocessor system components onto one chip while providing twice the performance of the standard 8086. The 80186 is object code compatible with the 8086/8088 microprocessors and adds 10 new instruction types to the 8086/8088 instruction set.

For more detailed information on the architecture, please refer to the 80C186XL/80C188XL User's Manual. The 80186 and the 80186XL devices are functionally and register compatible.

CLOCK GENERATOR

The processor provides an on-chip clock generator for both internal and external clock generation. The clock generator features a crystal oscillator, a divide-by-two counter, synchronous and asynchronous ready inputs, and reset circuitry.

Oscillator

The oscillator circuit is designed to be used with a parallel resonant fundamental mode crystal. This is used as the time base for the processor. The crystal frequency selected will be double the CPU clock frequency. Use of an LC or RC circuit is not recommended with this oscillator. If an external oscillator is used, it can be connected directly to the input pin X1 in lieu of a crystal. The output of the oscillator is not directly available outside the processor. The recommended crystal configuration is shown in Figure 5.

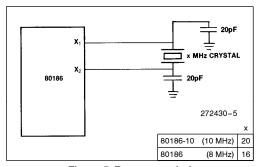


Figure 5. Recommended Crystal Configuration

Intel recommends the following values for crystal selection parameters:

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Clock Generator

The clock generator provides the 50% duty cycle processor clock for the processor. It does this by dividing the oscillator output by 2 forming the symmetrical clock. If an external oscillator is used, the state of the clock generator will change on the falling edge of the oscillator signal. The CLKOUT pin provides the processor clock signal for use outside the device. This may be used to drive other system components. All timings are referenced to the output clock.

READY Synchronization

The processor provides both synchronous and asynchronous ready inputs. In addition, the processor, as part of the integrated chip-select logic, has the capability to program WAIT states for memory and peripheral blocks.

RESET Logic

The processor provides both a $\overline{\text{RES}}$ input pin and a synchronized RESET output pin for use with other system components. The $\overline{\text{RES}}$ input pin is provided with hysteresis in order to facilitate power-on Reset generation via an RC network. RESET output is guaranteed to remain active for at least five clocks given a $\overline{\text{RES}}$ input of at least six clocks.

LOCAL BUS CONTROLLER

The processor provides a local bus controller to generate the local bus control signals. In addition, it employs a HOLD/HLDA protocol for relinquishing the local bus to other bus masters. It also provides outputs that can be used to enable external buffers and to direct the flow of data on and off the local bus.



Memory/Peripheral Control

The processor provides ALE, $\overline{\text{RD}}$, and $\overline{\text{WR}}$ bus control signals. The $\overline{\text{RD}}$ and $\overline{\text{WR}}$ signals are used to strobe data from memory or I/O to the processor or to strobe data from the processor to memory or I/O. The ALE line provides a strobe to latch the address when it is valid. The local bus controller does not provide a memory/ $\overline{\text{I/O}}$ signal. If this is required, use the $\overline{\text{S2}}$ signal (which will require external latching), make the memory and I/O spaces nonoverlapping, or use only the integrated chip-select circuitry.

Local Bus Arbitration

The processor uses a HOLD/HLDA system of local bus exchange. This provides an asynchronous bus exchange mechanism. This means multiple masters utilizing the same bus can operate at separate clock frequencies. The processor provides a single HOLD/HLDA pair through which all other bus masters may gain control of the local bus. External circuitry must arbitrate which external device will gain control of the bus when there is more than one alternate local bus master. When the processor relinquishes control of the local bus, it floats $\overline{\rm DEN}$, $\overline{\rm RD}$, $\overline{\rm WR}$, $\overline{\rm SO} = \overline{\rm S2}$, $\overline{\rm LOCK}$, $\overline{\rm AD0} = \overline{\rm AD15}$ (AD0 = AD7), A16 = A19 (A8 = A19), $\overline{\rm BHE}$ (S7), and DT/ $\overline{\rm R}$ to allow another master to drive these lines directly.

Local Bus Controller and Reset

During RESET the local bus controller will perform the following action:

 Drive DEN, RD, and WR HIGH for one clock cycle, then float.

NOTE:

 $\overline{\text{RD}}$ is also provided with an internal pull-up device to prevent the processor from inadvertently entering Queue Status Mode during RESET.

- Drive S0-S2 to the inactive state (all HIGH) and then float.
- Drive LOCK HIGH and then float.
- Float AD0-15 (AD0-AD7), A16-19 (A8-A19), BHE (S7), DT/R.
- Drive ALE LOW (ALE is never floated).
- Drive HLDA LOW.

PERIPHERAL ARCHITECTURE

All of the integrated peripherals are controlled by 16-bit registers contained within an internal 256-byte control block. The control block may be mapped into

either memory or I/O space. Internal logic will recognize control block addresses and respond to bus cycles. During bus cycles to internal registers, the bus controller will signal the operation externally (i.e., the $\overline{\text{RD}}$, $\overline{\text{WR}}$, status, address, data, etc., lines will be driven as in a normal bus cycle), but D₁₅₋₀ (D₇₋₀), SRDY, and ARDY will be ignored. The base address of the control block must be on an even 256-byte boundary (i.e., the lower 8 bits of the base address are all zeros).

The control block base address is programmed by a 16-bit relocation register contained within the control block at offset FEH from the base address of the control block. It provides the upper 12 bits of the base address of the control block.

In addition to providing relocation information for the control block, the relocation register contains bits which place the interrupt controller into Slave Mode, and cause the CPU to interrupt upon encountering ESC instructions.

Chip-Select/Ready Generation Logic

The processor contains logic which provides programmable chip-select generation for both memories and peripherals. In addition, it can be programmed to provide READY (or WAIT state) generation. It can also provide latched address bits A1 and A2. The chip-select lines are active for all memory and I/O cycles in their programmed areas, whether they be generated by the CPU or by the integrated DMA unit.

MEMORY CHIP SELECTS

The processor provides 6 memory chip select outputs for 3 address areas; upper memory, lower memory, and midrange memory. One each is provided for upper memory and lower memory, while four are provided for midrange memory.

UPPER MEMORY CS

The processor provides a chip select, called $\overline{\text{UCS}}$, for the top of memory. The top of memory is usually used as the system memory because after reset the processor begins executing at memory location FFFFOH

LOWER MEMORY CS

The processor provides a chip select for low memory called \overline{LCS} . The bottom of memory contains the interrupt vector table, starting at location 00000H.



The lower limit of memory defined by this chip select is always 0H, while the upper limit is programmable. By programming the upper limit, the size of the memory block is defined.

MID-RANGE MEMORY CS

The processor provides four $\overline{\text{MCS}}$ lines which are active within a user-locatable memory block. This block can be located within the 1-Mbyte memory address space exclusive of the areas defined by $\overline{\text{UCS}}$ and $\overline{\text{LCS}}$. Both the base address and size of this memory block are programmable.

PERIPHERAL CHIP SELECTS

The processor can generate chip selects for up to seven peripheral devices. These chip selects are active for seven contiguous blocks of 128 bytes above a programmable base address. The base address may be located in either memory or I/O space. Seven CS lines called PCS0_6 are generated by the processor. PCS5 and PCS6 can also be programmed to provide latched address bits A1 and A2. If so programmed, they cannot be used as peripheral selects. These outputs can be connected directly to the A0 and A1 pins used for selecting internal registers of 8-bit peripheral chips.

READY GENERATION LOGIC

The processor can generate a READY signal internally for each of the memory or peripheral \overline{CS} lines. The number of WAIT states to be inserted for each peripheral or memory is programmable to provide 0–3 wait states for all accesses to the area for which the chip select is active. In addition, the processor may be programmed to either ignore external READY for each chip-select range individually or to factor external READY with the integrated ready generator.

CHIP SELECT/READY LOGIC AND RESET

Upon RESET, the Chip-Select/Ready Logic will perform the following actions:

• All chip-select outputs will be driven HIGH.

- Upon leaving RESET, the UCS line will be programmed to provide chip selects to a 1K block with the accompanying READY control bits set at 011 to insert 3 wait states in conjunction with external READY (i.e., UMCS resets to FFFBH).
- No other chip select or READY control registers have any predefined values after RESET. They will not become active until the CPU accesses their control registers. Both the PACS and MPCS registers must be accessed before the PCS lines will become active.

DMA Channels

The DMA controller provides two independent DMA channels. Data transfers can occur between memory and I/O spaces (e.g., Memory to I/O) or within the same space (e.g., Memory to Memory or I/O to I/O). Data can be transferred either in bytes or in words (80186 only) to or from even or odd addresses. Each DMA channel maintains both a 20-bit source and destination pointer which can be optionally incremented or decremented after each data transfer (by one or two depending on byte or word transfers). Each data transfer consumes 2 bus cycles (a minimum of 8 clocks), one cycle to fetch data and the other to store data. This provides a maximum data transfer rate of 1.25 Mword/sec or 2.5 Mbytes/sec at 10 MHz (half of this rate for the 80188).

DMA CHANNELS AND RESET

Upon RESET, the DMA channels will perform the following actions:

- The Start/Stop bit for each channel will be reset to STOP.
- · Any transfer in progress is aborted.

Timers

The processor provides three internal 16-bit programmable timers. Two of these are highly flexible and are connected to four external pins (2 per timer). They can be used to count external events, time external events, generate nonrepetitive waveforms, etc. The third timer is not connected to any external pins, and is useful for real-time coding and time delay applications. In addition, the third timer can be used as a prescaler to the other two, or as a DMA request source.



TIMERS AND RESET

Upon RESET, the Timers will perform the following actions:

- All EN (Enable) bits are reset preventing timer counting.
- For Timers 0 and 1, the RIU bits are reset to zero and the ALT bits are set to one. This results in the Timer Out pins going high.

Interrupt Controller

The processor can receive interrupts from a number of sources, both internal and external. The internal interrupt controller serves to merge these requests on a priority basis, for individual service by the CPU.

Internal interrupt sources (Timers and DMA channels) can be disabled by their own control registers or by mask bits within the interrupt controller. The interrupt controller has its own control register that sets the mode of operation for the controller.

INTERRUPT CONTROLLER AND RESET

Upon RESET, the interrupt controller will perform the following actions:

- All SFNM bits reset to 0, implying Fully Nested Mode
- All PR bits in the various control registers set to 1.
 This places all sources at lowest priority (level 111)
- All LTM bits reset to 0, resulting in edge-sense mode.
- All Interrupt Service bits reset to 0.
- All Interrupt Request bits reset to 0.
- All MSK (Interrupt Mask) bits set to 1 (mask).
- All C (Cascade) bits reset to 0 (non-Cascade).
- All PRM (Priority Mask) bits set to 1, implying no levels masked.
- Initialized to Master Mode.



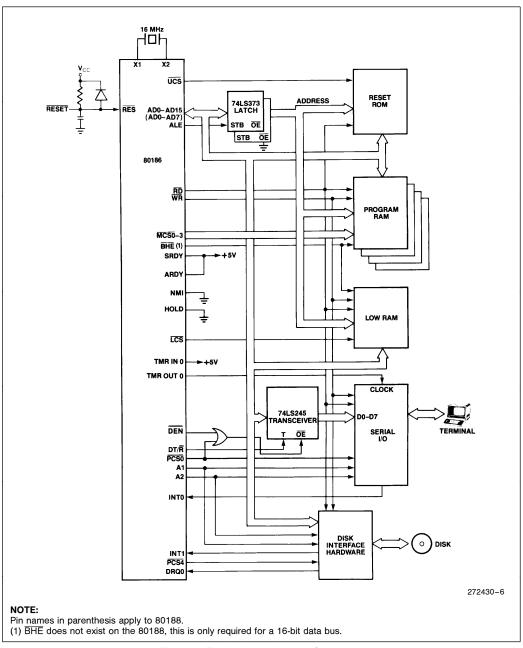


Figure 6. Typical 80186/80188 Computer



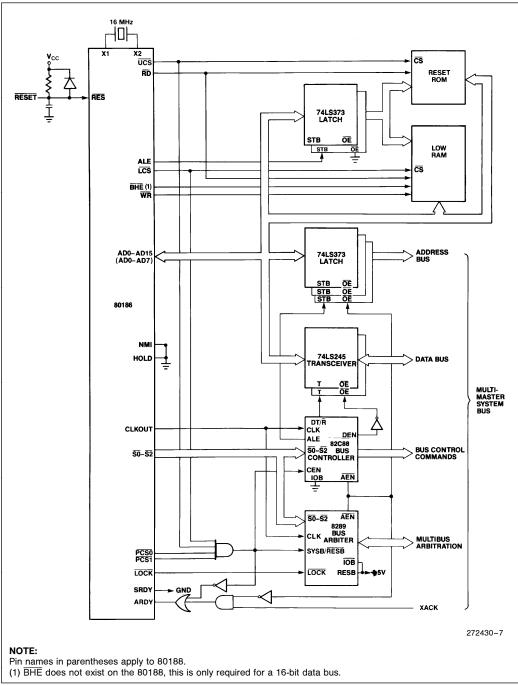


Figure 7. Typical 80186/80188 Multi-Master Bus Interface



ABSOLUTE MAXIMUM RATINGS*

Ambient Temperature under Bias0°C to 70)°C
Storage Temperature65°C to +150)°C
Voltage on any Pin with Respect to Ground 1.0V to +	7V
Power Dissipation	3W

NOTICE: This is a production data sheet. The specifications are subject to change without notice.

*WARNING: Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent damage. These are stress ratings only. Operation beyond the "Operating Conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect device reliability.

D.C. CHARACTERISTICS (T_A = 0°C to +70°C, V_{CC} = 5V \pm 10%) Applicable to 8 MHz and 10 MHz devices.

Symbol	Parameter	Min	Max	Units	Test Conditions
V _{IL}	Input Low Voltage	-0.5	+0.8	V	
V _{IH}	Input High Voltage (All except X1 and (RES)	2.0	V _{CC} + 0.5	V	
V _{IH1}	Input High Voltage (RES)	3.0	V _{CC} + 0.5	V	
V _{OL}	Output Low Voltage		0.45	V	$I_a = 2.5 \text{ mA for } \overline{\$0} - \overline{\$2}$ $I_a = 2.0 \text{ mA for all other Outputs}$
V _{OH}	Output High Voltage	2.4		V	$I_{oa} = -400 \mu A$
Icc	Power Supply Current		600*	mA	$T_A = -40^{\circ}C$
			550	mA	$T_A = 0$ °C
			415	mA	$T_A = +70^{\circ}C$
ILI	Input Leakage Current		±10	μΑ	$ov < v_{IN} < v_{CC}$
I _{LO}	Output Leakage Current		±10	μΑ	$0.45V < V_{OUT} < V_{CC}$
V_{CLO}	Clock Output Low		0.6	V	$I_a = 4.0 \text{ mA}$
V_{CHO}	Clock Output High	4.0		V	$I_{oa} = -200 \mu A$
V _{CLI}	Clock Input Low Voltage	-0.5	0.6	V	
V _{CHI}	Clock Input High Voltage	3.9	V _{CC} + 1.0	V	
C _{IN}	Input Capacitance		10	pF	
C _{IO}	I/O Capacitance		20	pF	

^{*}For extended temperature parts only.



A.C. CHARACTERISTICS (T_A = 0°C to +70°C, V_{CC} = 5V $\pm 10\%$) Timing Requirements All Timings Measured At 1.5V Unless Otherwise Noted.

Corrects and	Dawamatau	8 MHz		10 MH:	z	I I mile n	Test
Symbol	Parameter	Min	Max	Min	Max	Units	Conditions
T _{DVCL}	Data in Setup (A/D)	20		15		ns	
T _{CLDX}	Data in Hold (A/D)	10		8		ns	
T _{ARYHCH}	Asynchronous Ready (ARDY) Active Setup Time ⁽¹⁾	20		15		ns	
T _{ARYLCL}	ARDY Inactive Setup Time	35		25		ns	
T _{CLARX}	ARDY Hold Time	15		15		ns	
T _{ARYCHL}	Asynchronous Ready Inactive Hold Time	15		15		ns	
T _{SRYCL}	Synchronous Ready (SRDY) Transition Setup Time ⁽²⁾	20		20		ns	
T _{CLSRY}	SRDY Transition Hold Time ⁽²⁾	15		15		ns	
T _{HVCL}	HOLD Setup ⁽¹⁾	25		20		ns	
T _{INVCH}	INTR, NMI, TEST, TIM IN, Setup ⁽¹⁾	25		25		ns	
T _{INVCL}	DRQ0, DRQ1, Setup(1)	25		20		ns	

Master Interface Timing Responses

T _{CLAV}	Address Valid Delay	5	55	5	44	ns	C _L = 20 pF-200 pF
T _{CLAX}	Address Hold	10		10		ns	all Outputs (Except T _{CLTMV}) @
T _{CLAZ}	Address Float Delay	T _{CLAX}	35	T _{CLAX}	30	ns	8 MHz and 10 MHz
T _{CHCZ}	Command Lines Float Delay		45		40	ns	
T _{CHCV}	Command Lines Valid Delay (after Float)		55		45	ns	
T _{LHLL}	ALE Width	T _{CLCL} -35		T _{CLCL} -30		ns	
T _{CHLH}	ALE Active Delay		35		30	ns	
T _{CHLL}	ALE Inactive Delay		35		30	ns	
T _{LLAX}	Address Hold from ALE Inactive	T _{CHCL} -25		T _{CHCL} -20		ns	
T _{CLDV}	Data Valid Delay	10	44	10	40	ns	
T _{CLDOX}	Data Hold Time	10		10		ns	
T _{WHDX}	Data Hold after WR	T _{CLCL} -40		T _{CLCL} -34		ns	
T _{CVCTV}	Control Active Delay 1	5	50	5	40	ns	
T _{CHCTV}	Control Active Delay 2	10	55	10	44	ns	
T _{CVCTX}	Control Inactive Delay	5	55	5	44	ns	
T _{CVDEX}	DEN Inactive Delay (Non-Write Cycle)	10	70	10	56	ns	

To guarantee recognition at next clock.
 To guarantee proper operation.



A.C. CHARACTERISTICS (T_A = 0°C to +70°C, V_{CC} = 5V $\pm 10\%$) (Continued) Master Interface Timing Responses (Continued)

Orange - 1	Davamatav	8 MHz		10 MHz		1144.	Test
Symbol	Parameter	Min	Max	Min	Max	Units	Conditions
T _{AZRL}	Address Float to RD Active	0		0		ns	
T _{CLRL}	RD Active Delay	10	70	10	56	ns	
T _{CLRH}	RD Inactive Delay	10	55	10	44	ns	
T _{RHAV}	RD Inactive to Address Active	T _{CLCL} -40		T _{CLCL} -40		ns	
T _{CLHAV}	HLDA Valid Delay	5	50	5	40	ns	
T _{RLRH}	RD Width	2T _{CLCL} -50		2T _{CLCL} -46		ns	
T_{WLWH}	WR Width	2T _{CLCL} -40		2T _{CLCL} -34		ns	
T _{AVLL}	Address Valid to ALE Low	T _{CLCH} -25		T _{CLCH} -19		ns	
T _{CHSV}	Status Active Delay	10	55	10	45	ns	
T _{CLSH}	Status Inactive Delay	10	65	10	50	ns	
T _{CLTMV}	Timer Output Delay		60		48	ns	100 pF max @ 8 & 10 MH
T _{CLRO}	Reset Delay		60		48	ns	
T _{CHQSV}	Queue Status Delay		35		28	ns	
T _{CHDX}	Status Hold Time	10		10		ns	
T _{AVCH}	Address Valid to Clock High	10		10		ns	
T _{CLLV}	LOCK Valid/Invalid Delay	5	65	5	60	ns	
Chip-Selec	t Timing Responses						
T _{CLCSV}	Chip-Select Active Delay		66		45	ns	
T _{CXCSX}	Chip-Select Hold from Command Inactive	35		35		ns	
T _{CHCSX}	Chip-Select Inactive Delay	5	35	5	32	ns	
CLKIN Rec	quirements						
T _{CKIN}	CLKIN Period	62.5	250	50	250	ns	
T _{CKHL}	CLKIN Fall Time		10		10	ns	3.5 to 1.0V
T _{CKLH}	CLKIN Rise Time		10		10	ns	1.0 to 3.5V
T _{CLCK}	CLKIN Low Time	25		20		ns	1.5V
T _{CHCK}	CLKIN High Time	25		20		ns	1.5V
CLKOUT T	iming (200 pF load)						
T _{CICO}	CLKIN to CLKOUT Skew		50		25	ns	
T _{CLCL}	CLKOUT Period	125	500	100	500	ns	
T _{CLCH}	CLKOUT Low Time	½ T _{CLCL} −7.5		½ T _{CLCL} −6.0		ns	1.5V
T _{CHCL}	CLKOUT High Time	½ T _{CLCL} −7.5		½ T _{CLCL} −6.0		ns	1.5V
T _{CH1CH2}	CLKOUT Rise Time		15		12	ns	1.0 to 3.5V
T _{CL2CL1}	CLKOUT Fall Time		15		12	ns	3.5 to 1.0V

80186/80188



EXPLANATION OF THE AC SYMBOLS

Each timing symbol has from 5 to 7 characters. The first character is always a "T" (stands for time). The other characters, depending on their positions, stand for the name of a signal or the logical status of that signal. The following is a list of all the characters and what they stand for.

Address

ARY: Asynchronous Ready Input

Clock Output CK: Clock Input CS: Chip Select

Control (DT/R, DEN, ...) CT:

D: Data Input DE: DEN

Logic Level High

Input (DRQ0, TIM0, ...) IN: Logic Level Low or ALE L:

O: Output

QS: Queue Status (QS1, QS2) RD signal, RESET signal Status (S0, S1, S2) R: S:

SRY: Synchronous Ready Input

V: Valid WR Signal W:

X: Z: No Longer a Valid Logic Level

Float

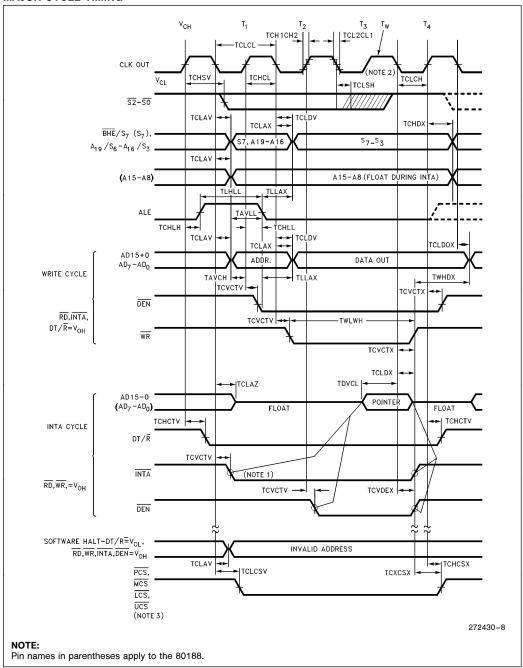
Examples:

 $\begin{array}{ll} T_{CLAV} & -\text{Time from Clock low to Address valid} \\ T_{CHLH} & -\text{Time from Clock high to ALE high} \\ T_{CLCSV} - \text{Time from Clock low to Chip Select valid} \end{array}$



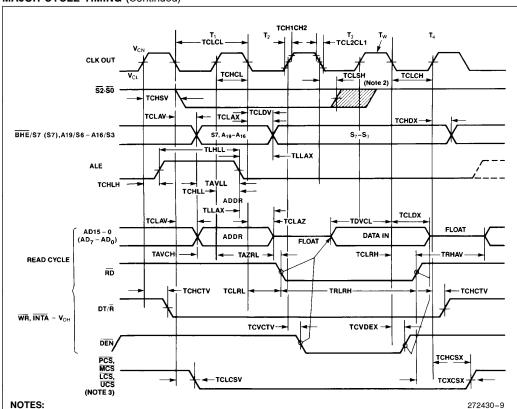
WAVEFORMS

MAJOR CYCLE TIMING



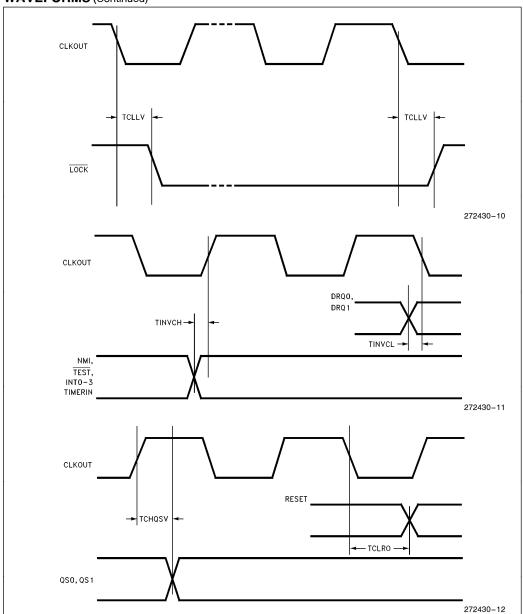


MAJOR CYCLE TIMING (Continued)

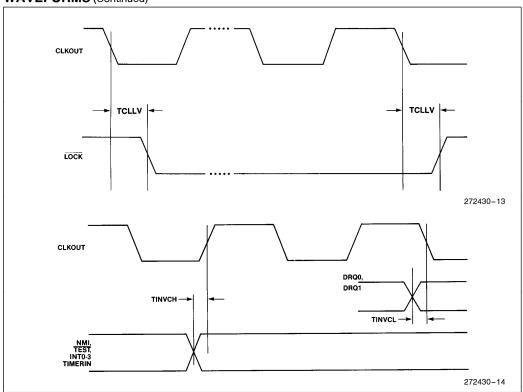


- INTA occurs one clock later in slave mode.
 Status inactive just prior to T₄.
 If latched A1 and A2 are selected instead of PCS5 and PCS6, only T_{CLCSV} is applicable.
- 4. Pin names in parentheses apply to the 80188.

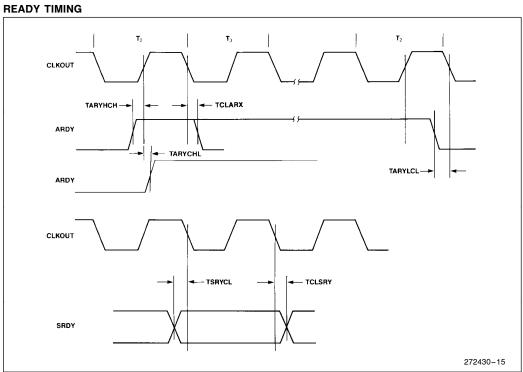






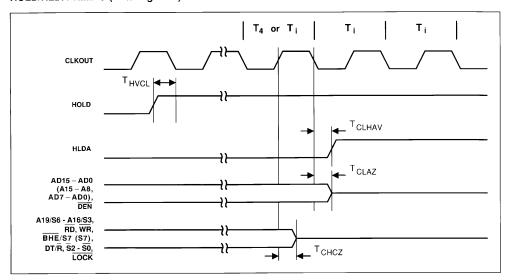




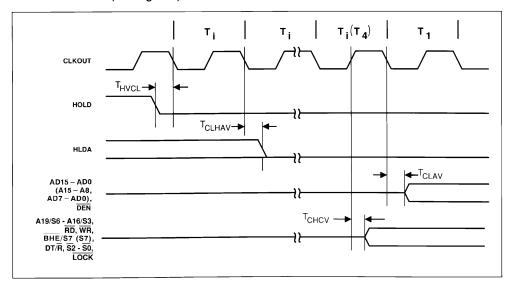




HOLD/HLDA TIMING (Entering Hold)



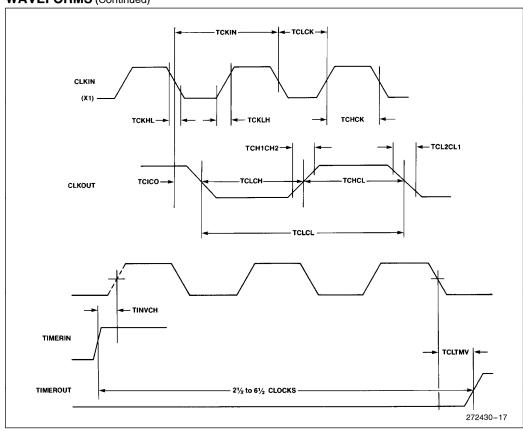
HOLD/HLDA TIMING (Leaving Hold)



272430-16

NOTE:





EXPRESS

The Intel EXPRESS system offers enhancements to the operational specifications of the microprocessor. EXPRESS products are designed to meet the needs of those applications whose operating requirements exceed commercial standards.

The EXPRESS program includes the commercial standard temperature range with burn-in and an extended temperature range without burn-in.

With the commercial standard temperature range operational characteristics are guaranteed over the temperature range of 0°C to +70°C. With the extended temperature range option, operational characteristics are guaranteed over the range of -40°C to +85°C.

The optional burn-in is dynamic, for a minimum time of 160 hours at $+125^{\circ}$ C with $V_{CC}=5.5V\pm0.25V$, following guidelines in MIL-STD-883, Method 1015.

Package types and EXPRESS versions are identified by a one- or two-letter prefix to the part number. The prefixes are listed in Table 2. All A.C. and D.C. specifications not mentioned in this section are the same for both commercial and EXPRESS parts.

Table 2. Prefix Identification

Prefix	Package Type	Temperature Range	Burn-In
Α	PGA	Commercial	No
N	PLCC	Commercial	No
R	LCC	Commercial	No
TA	PGA	Extended	No
QA	PGA	Commercial	Yes
QR	LCC	Commercial	Yes

NOTE

Not all package/temperature range/speed combinations are available.



EXECUTION TIMINGS

A determination of program execution timing must consider the bus cycles necessary to prefetch instructions as well as the number of execution unit cycles necessary to execute instructions. The following instruction timings represent the minimum execution time in clock cycles for each instruction. The timings given are based on the following assumptions:

- The opcode, along with any data or displacement required for execution of a particular instruction, has been prefetched and resides in the queue at the time it is needed.
- · No wait states or bus HOLDS occur.
- All word-data is located on even-address boundaries.

All instructions which involve memory accesses can also require one or two additional clocks above the minimum timings shown due to the asynchronous handshake between the bus interface unit (BIU) and execution unit.

All jumps and calls include the time required to fetch the opcode of the next instruction at the destination address.

The 80186 has sufficient bus performance to ensure that an adequate number of prefetched bytes will reside in the queue (6 bytes) most of the time. Therefore, actual program execution time will not be substantially greater than that derived from adding the instruction timings shown.

The 80188 is noticeably limited in its performance relative to the execution unit. A sufficient number of prefetched bytes may not reside in the prefetch queue (4 bytes) much of the time. Therefore, actual program execution time may be substantially greater than that derived from adding the instruction timings shown.



INSTRUCTION SET SUMMARY

Function		Fo	rmat		80186 Clock Cycles	80188 Clock Cycles	Comments
DATA TRANSFER MOV = Move:					-		
Register to Register/Memory	1000100w	mod reg r/m			2/12	2/12*	
Register/memory to register	1000101w	mod reg r/m			2/9	2/9*	
Immediate to register/memory	1100011w	mod 000 r/m	data	data if w=1	12/13	12/13	8/16-bit
Immediate to register	1011w reg	data	data if w=1]	3/4	3/4	8/16-bit
Memory to accumulator	1010000w	addr-low	addr-high]	8	8*	
Accumulator to memory	1010001w	addr-low	addr-high]	9	9*	
Register/memory to segment register	10001110	mod 0 reg r/m			2/9	2/13	
Segment register to register/memory	10001100	mod 0 reg r/m			2/11	2/15	
PUSH = Push:							
Memory	11111111	mod 1 1 0 r/m			16	20	
Register	01010 reg				10	14	
Segment register	0 0 0 reg 1 1 0				9	13	
Immediate	011010s0	data	data if s=0		10	14	
PUSHA = Push All	01100000				36	68	
POP = Pop:	01100000				00	00	
Memory	10001111	mod 0 0 0 r/m			20	24	
Register	01011 reg				10	14	
Segment register	0 0 0 reg 1 1 1	(reg≠01)			8	12	
POPA = Pop All	01100001				51	83	
XCHG = Exchange:							
Register/memory with register	1000011w	mod reg r/m			4/17	4/17*	
Register with accumulator	10010 reg				3	3	
IN = Input from:							
Fixed port	1110010w	port			10	10*	
Variable port	1110110w				8	8*	
OUT = Output to:							
Fixed port	1110011w	port			9	9*	
Variable port	1110111w				7	7*	
XLAT = Translate byte to AL	11010111				11	15	
LEA = Load EA to register	10001101	mod reg r/m			6	6	
LDS = Load pointer to DS	11000101	mod reg r/m	(mod≠11)		18	26	
LES = Load pointer to ES	11000100	mod reg r/m	(mod≠11)		18	26	
LAHF = Load AH with flags	10011111				2	2	
SAHF = Store AH into flags	10011110				3	3	
PUSHF = Push flags	10011100				9	13	
POPF = Pop flags	10011101				8	12	

Shaded areas indicate instructions not available in 8086, 8088 microsystems.

NOTE:*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for each memory transfer.



INSTRUCTION SETS	SOMMAN	(Continued)			80186	80188	
Function		Fo	rmat		Clock Cycles	Clock Cycles	Comments
DATA TRANSFER (Continued) SEGMENT = Segment Override:							
cs	00101110				2	2	
ss	00110110				2	2	
DS	00111110				2	2	
ES	00100110				2	2	
ARITHMETIC ADD = Add:							
Reg/memory with register to either	00000dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	100000sw	mod 0 0 0 r/m	data	data if s w=01	4/16	4/16*	
Immediate to accumulator	0000010w	data	data if w=1]	3/4	3/4	8/16-bit
ADC = Add with carry:							
Reg/memory with register to either	000100dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	100000sw	mod 0 1 0 r/m	data	data if s w=01	4/16	4/16*	
Immediate to accumulator	0001010w	data	data if w = 1]	3/4	3/4	8/16-bit
INC = Increment:							
Register/memory	1111111w	mod 0 0 0 r/m			3/15	3/15*	
Register	0 1 0 0 0 reg				3	3	
SUB = Subtract:							
Reg/memory and register to either	001010dw	mod reg r/m			3/10	3/10*	
Immediate from register/memory	100000sw	mod 1 0 1 r/m	data	data if s w=01	4/16	4/16*	
Immediate from accumulator	0010110w	data	data if $w = 1$		3/4	3/4	8/16-bit
SBB = Subtract with borrow:							
Reg/memory and register to either	000110dw	mod reg r/m			3/10	3/10*	
Immediate from register/memory	100000sw	mod 0 1 1 r/m	data	data if s w=01	4/16	4/16*	
Immediate from accumulator	0001110w	data	data if w=1]	3/4	3/4	8/16-bit
DEC = Decrement							
Register/memory	1111111W	mod 0 0 1 r/m			3/15	3/15*	
Register	01001 reg				3	3	
CMP = Compare:							
Register/memory with register	0011101w	mod reg r/m			3/10	3/10*	
Register with register/memory	0011100w	mod reg r/m			3/10	3/10*	
Immediate with register/memory	100000sw	mod 1 1 1 r/m	data	data if s w=01	3/10	3/10*	
Immediate with accumulator	0011110w	data	data if w=1		3/4	3/4	8/16-bit
NEG = Change sign register/memory	1111011w	mod 0 1 1 r/m			3/10	3/10*	
AAA = ASCII adjust for add	00110111				8	8	
DAA = Decimal adjust for add	00100111				4	4	
AAS = ASCII adjust for subtract	00111111				7	7	
DAS = Decimal adjust for subtract	00101111				4	4	
MUL = Multiply (unsigned):	1111011w	mod 100 r/m					
Register-Byte Register-Word					26-28 35-37	26-28 35-37	
Memory-Byte					32-34	32-34	
Memory-Word					41-43	41-43*	

Shaded areas indicate instructions not available in 8086, 8088 microsystems.

NOTE:

*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for each memory transfer.



Function	Format				80186 Clock	80188 Clock	Comments
					Cycles	Cycles	
ARITHMETIC (Continued) IMUL = Integer multiply (signed):	1111011w	mod 1 0 1 r/m	1				
Register-Byte Register-Word Memory-Byte Memory-Word		mod 1 0 1 17m	I		25-28 34-37 31-34 40-43	25-28 34-37 31-34 40-43*	
IMUL = Integer Immediate multiply (signed)	011010s1	mod reg r/m	data	data if s=0	22-25/ 29-32	22-25/ 29-32	
DIV = Divide (unsigned):	1111011w	mod 1 1 0 r/m					
Register-Byte Register-Word Memory-Byte Memory-Word					29 38 35 44	29 38 35 44*	
IDIV = Integer divide (signed):	1111011w	mod 1 1 1 r/m					
Register-Byte Register-Word Memory-Byte Memory-Word					44-52 53-61 50-58 59-67	44-52 53-61 50-58 59-67*	
AAM = ASCII adjust for multiply	11010100	00001010			19	19	
AAD = ASCII adjust for divide	11010101	00001010			15	15	
CBW = Convert byte to word	10011000				2	2	
CWD = Convert word to double word	10011001				4	4	
LOGIC							
Shift/Rotate Instructions: Register/Memory by 1	1101000w	mod TTT r/m			2/15	2/15	
Register/Memory by CL	1101000W						
Register/Memory by Count	1100000w	mod TTT r/m	count			5+n/17+n 5+n/17+n	
		TTT Instruction 000 ROL 001 ROR 010 RCL 011 RCR 1100 SHL/SAL 101 SHR 1111 SAR					
AND = And:			1				
Reg/memory and register to either	001000dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	1000000w	mod 1 0 0 r/m	data	data if w=1	4/16	4/16*	
Immediate to accumulator	0010010w	data	data if w=1		3/4	3/4	8/16-bit
TEST = And function to flags, no result:							
Register/memory and register	1000010w	mod reg r/m			3/10	3/10*	
Immediate data and register/memory	1111011w	mod 0 0 0 r/m	data	data if w=1	4/10	4/10*	
Immediate data and accumulator	1010100w	data	data if w=1		3/4	3/4	8/16-bit
OR=Or:			1				
Reg/memory and register to either	000010dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	1000000w	mod 0 0 1 r/m	data	data if w=1	4/16	4/16*	
Immediate to accumulator	0000110w	data	data if w = 1		3/4	3/4	8/16-bit

Shaded areas indicate instructions not available in 8086, 8088 microsystems.

NOTE:*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for each memory transfer.



Function	Format			80186 Clock Cycles	80188 Clock Cycles	Comments	
LOGIC (Continued) XOR = Exclusive or:	_						
Reg/memory and register to either	001100dw	mod reg r/m			3/10	3/10*	
Immediate to register/memory	1000000w	mod 1 1 0 r/m	data	data if w=1	4/16	4/16*	
Immediate to accumulator	0011010w	data	data if w=1		3/4	3/4	8/16-bit
NOT = Invert register/memory	1111011w	mod 0 1 0 r/m			3/10	3/10*	
STRING MANIPULATION		1					
MOVS = Move byte/word	1010010w				14	14*	
CMPS = Compare byte/word	1010011w				22	22*	
SCAS = Scan byte/word	1010111w				15	15*	
LODS = Load byte/wd to AL/AX	1010110w				12	12*	
STOS = Store byte/wd from AL/AX	1010101w				10	10*	
INS = Input byte/wd from DX port	0110110w				14	14	
OUTS = Output byte/wd to DX port	0110111w				14	14	
Repeated by count in CX (REP/REPE/	REPZ/REPNE/REPI	NZ)					
MOVS = Move string	11110010	1010010w			8+8n	8+8n*	
CMPS = Compare string	1111001z	1010011w			5+22n	5+22n*	
SCAS = Scan string	1111001z	1010111w			5+15n	5 + 15n*	
LODS = Load string	11110010	1010110w			6+11n	6+11n*	
STOS = Store string	11110010	1010101w			6+9n	6+9n*	
INS = Input string	11110010	0110110w			8+8n	8+8n*	
OUTS = Output string	11110010	0110111w			8+8n	8+8n*	
CONTROL TRANSFER							
CALL = Call:							
Direct within segment	11101000	disp-low	disp-high		15	19	
Register/memory	11111111	mod 0 1 0 r/m			13/19	17/27	
indirect within segment							
Direct intersegment	10011010	segmen	t offset		23	31	
		segment	selector				
Indirect intersegment	11111111	mod 0 1 1 r/m	(mod ≠ 11)		38	54	
JMP = Unconditional jump:							
Short/long	11101011	disp-low			14	14	
Direct within segment	11101001	disp-low	disp-high		14	14	
Register/memory indirect within segment	11111111	mod 1 0 0 r/m			11/17	11/21	
Direct intersegment	11101010	segmen	t offset		14	14	
•		segment					
Indicat interaccus	444444			ı	00		
Indirect intersegment	11111111	mod 1 0 1 r/m	(mod ≠ 11)		26	34	

Shaded areas indicate instructions not available in 8086, 8088 microsystems.

NOTE:

 * Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for each memory transfer.



Function		Format	:		80186 Clock Cycles	80188 Clock Cycles	Comments
CONTROL TRANSFER (Continued) RET = Return from CALL:					,	j	
Within segment	11000011				16	20	
Within seg adding immed to SP	11000010	data-low	data-high]	18	22	
Intersegment	11001011				22	30	
Intersegment adding immediate to SP	11001010	data-low	data-high		25	33	
JE/JZ = Jump on equal/zero	01110100	disp			4/13	4/13	JMP not
JL/JNGE = Jump on less/not greater or equal	01111100	disp			4/13	4/13	taken/JMP taken
JLE/JNG = Jump on less or equal/not greater	01111110	disp			4/13	4/13	
JB/JNAE = Jump on below/not above or equal	01110010	disp			4/13	4/13	
JBE/JNA = Jump on below or equal/not above	01110110	disp			4/13	4/13	
JP/JPE = Jump on parity/parity even	01111010	disp			4/13	4/13	
JO = Jump on overflow	01110000	disp			4/13	4/13	
JS = Jump on sign	01111000	disp			4/13	4/13	
JNE/JNZ = Jump on not equal/not zero	01110101	disp			4/13	4/13	
JNL/JGE = Jump on not less/greater or equal	01111101	disp			4/13	4/13	
JNLE/JG = Jump on not less or equal/greater	01111111	disp			4/13	4/13	
JNB/JAE = Jump on not below/above or equal	01110011	disp			4/13	4/13	
JNBE/JA = Jump on not below or equal/above	01110111	disp			4/13	4/13	
JNP/JPO = Jump on not par/par odd	01111011	disp			4/13	4/13	
JNO = Jump on not overflow	01110001	disp			4/13	4/13	
JNS = Jump on not sign	01111001	disp			4/13	4/13	
JCXZ = Jump on CX zero	11100011	disp			5/15	5/15	
LOOP = Loop CX times	11100010	disp			6/16	6/16	LOOP not
LOOPZ/LOOPE = Loop while zero/equal	11100001	disp			6/16	6/16	taken/LOOP taken
LOOPNZ/LOOPNE = Loop while not zero/equal	11100000	disp			6/16	6/16	taken
ENTER = Enter Procedure	11001000	data-low	data-high	L			
L = 0 L = 1 L > 1					15 25 22+16(n-1)	19 29 26+20(n-1)	
LEAVE = Leave Procedure	11001001				8	8	
INT = Interrupt:							
Type specified	11001101	type			47	47	
Туре 3	11001100				45	45	if INT. taken/
INTO = Interrupt on overflow	11001110				48/4	48/4	if INT. not taken
IRET = Interrupt return	11001111				28	28	
BOUND = Detect value out of range	01100010	mod reg r/m			33-35	33-35	

Shaded areas indicate instructions not available in 8086, 8088 microsystems.

NOTE:*Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for each memory transfer.



Function	Format	80186 Clock Cycles	80188 Clock Cycles	Comments
PROCESSOR CONTROL				
CLC = Clear carry	11111000	2	2	
CMC = Complement carry	11110101	2	2	
STC = Set carry	11111001	2	2	
CLD = Clear direction	11111100	2	2	
STD = Set direction	11111101	2	2	
CLI = Clear interrupt	11111010	2	2	
STI = Set interrupt	11111011	2	2	
HLT = Halt	11110100	2	2	
WAIT = Wait	10011011	6	6	if TEST = 0
LOCK = Bus lock prefix	11110000	2	3	
ESC = Processor Extension Escape	11011TTT mod LLL r/m	6	6	
	(TTT LLL are opcode to processor extension)			
NOP = No Operation	10010000	3	3	

Shaded areas indicate instructions not available in 8086, 8088 microsystems.

NOTE:

FOOTNOTES

The Effective Address (EA) of the memory operand is computed according to the mod and r/m fields:

if mod = 11 then r/m is treated as REG field				
if mod = 00 then DISP = 0*, disp-low and disp-high are absent				
if mod = 01 then DISP = disp-low sign-extended to 16-bits, disp-high				
is absent				
if mod = 10 then DISP = disp-high: disp-low				
if $r/m = 000$ then EA = (BX) + (SI) + DISP				
if $r/m = 001$ then EA = (BX) + (DI) + DISP				
if $r/m = 010$ then EA = (BP) + (SI) + DISP				
if $r/m = 011$ then EA = (BP) + (DI) + DISP				
if $r/m = 100$ then EA = (SI) + DISP				
if $r/m = 101$ then EA = (DI) + DISP				
if $r/m = 110$ then EA = (BP) + DISP*				
if $r/m = 111$ then EA = (BX) + DISP				

DISP follows 2nd byte of instruction (before data if required)

*except if mod = 00 and r/m = 110 then EA = disp-high: disp-low.

EA calculation time is 4 clock cycles for all modes, and is included in the execution times given whenever appropriate.

Segment Override Prefix

0 0 1 reg	1	1	0
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reg is assigned according to the following:

reg	Segmen Register
00	ES
01	CS
10	SS
11	DS

REG is assigned according to the following table:

16-Bit (w = 1)	8-Bit (w = 0)
000 AX	000 AL
001 CX	001 CL
010 DX	010 DL
011 BX	011 BL
100 SP	100 AH
101 BP	101 CH
110 SI	110 DH
111 DI	111 BH

The physical addresses of all operands addressed by the BP register are computed using the SS segment register. The physical addresses of the destination operands of the string primitive operations (those addressed by the DI register) are computed using the ES segment, which may not be overridden.

^{*}Clock cycles shown for byte transfers, for word operations, add 4 clock cycles for each memory transfer.

80186/80188



REVISION HISTORY

This data sheet replaces the following data sheets: 210706-011 80188 210451-011 80186